

# SS32BGF~SS320BGF

ROHS

## Surface Mount Schottky Barrier Rectifier

### Features

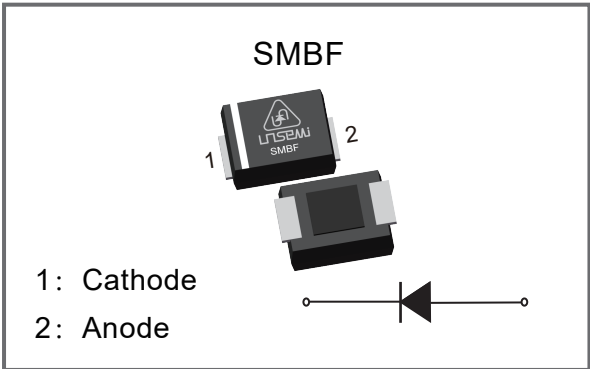
- ◆ Metal silicon junction, majority carrier conduction
- ◆ For surface mounted applications
- ◆ Low power loss, high efficiency
- ◆ High forward surge current capability
- ◆ For use in low voltage, high frequency inverters, free wheeling, and polarity protection applications

### Mechanical Data

- ◆ Case: SMBF
- ◆ Quantity Per Reel : 3,000pcs
- ◆ Approx. Weight : 57mg/0.002oz
- ◆ Terminals: Solderable per MIL-STD-750, Method 2026



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### Maximum Ratings and Electrical Characteristics

Ratings at 25°C ambient temperature unless otherwise specified.

Single phase half-wave 60Hz, resistive or inductive load, for capacitive load current derate by 20%.

Parameter		Symbol	SS32 BGF	SS34 BGF	SS36 BGF	SS38 BGF	SS310 BGF	SS312 BGF	SS315 BGF	SS320 BGF	Units
Maximum Repetitive Peak Reverse Voltage		VRRM	20	40	60	80	100	120	150	200	V
Maximum RMS Voltage		VRMS	14	28	42	56	70	84	105	140	V
Maximum DC Blocking Voltage		VDC	20	40	60	80	100	120	150	200	V
Maximum Average Forward Rectified Current		IF(AV)	3.0								A
Peak Forward Surge Current,8.3ms Single Half Sine-wave Superimposed on Rated Load (JEDEC method)		IFSM	80								A
Max Instantaneous Forward Voltage at 3A		VF	0.55		0.70		0.85		0.95		V
Maximum DC Reverse Current at Rated DC Reverse Voltage	Ta=25℃	IR	0.5		0.3						mA
	Ta=100℃	IR	5.0		3.0						
Typical Junction Capacitance <sup>(1)</sup>		Cj	450		400						pF
Typical Thermal Resistance <sup>(2)</sup>		RθJA	65								℃/W
Operating Junction Temperature Range		TJ	-55 ~ +150								℃
Storage Temperature Range		Tstg	-55 ~ +150								℃

Note:(1) Measured at 1 MHz and applied reverse voltage of 4VDC.

(2) P.C.B. mounted with 2.0" X 2.0" (5 X 5cm) copper pad areas.

### Electrical Characteristics Curves

Fig.1 Forward Current Derating Curve

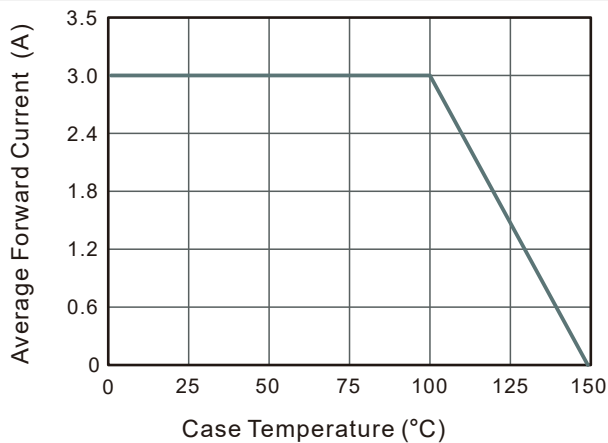


Fig. 2 Typical Reverse Characteristics

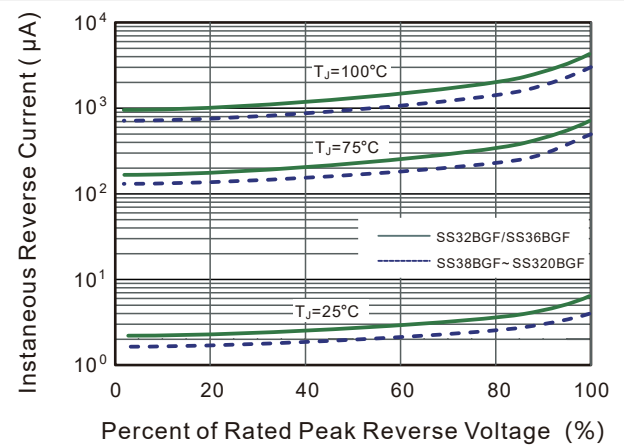


Fig.3 Typical Forward Characteristic

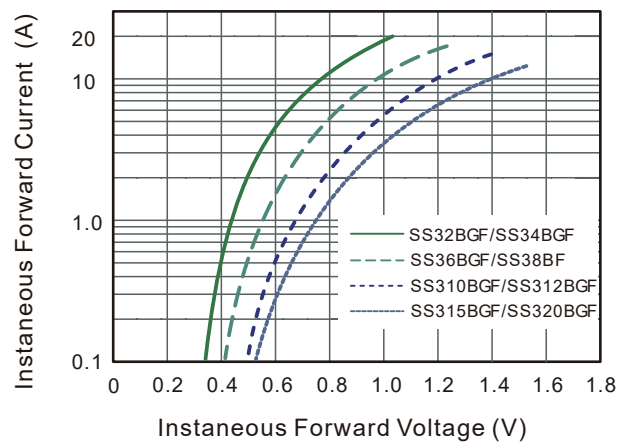


Fig. 4 Typical Junction Capacitance

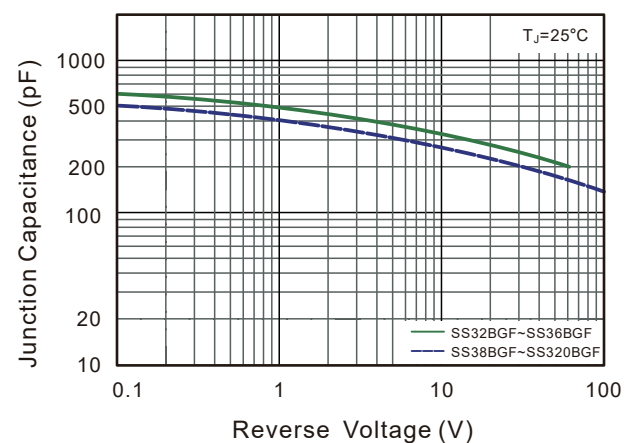


Fig.5 Maximum Non-Repetitive Peak Forward Surge Current

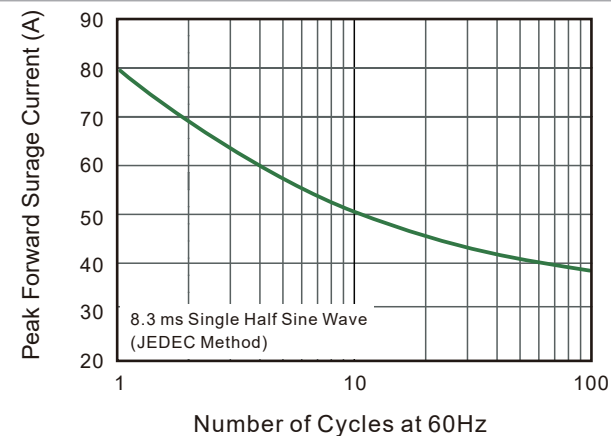
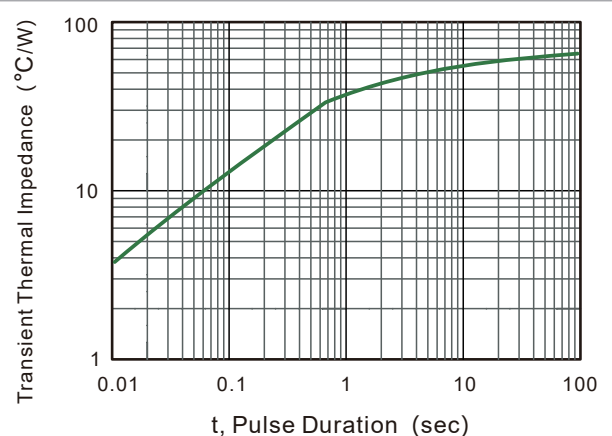
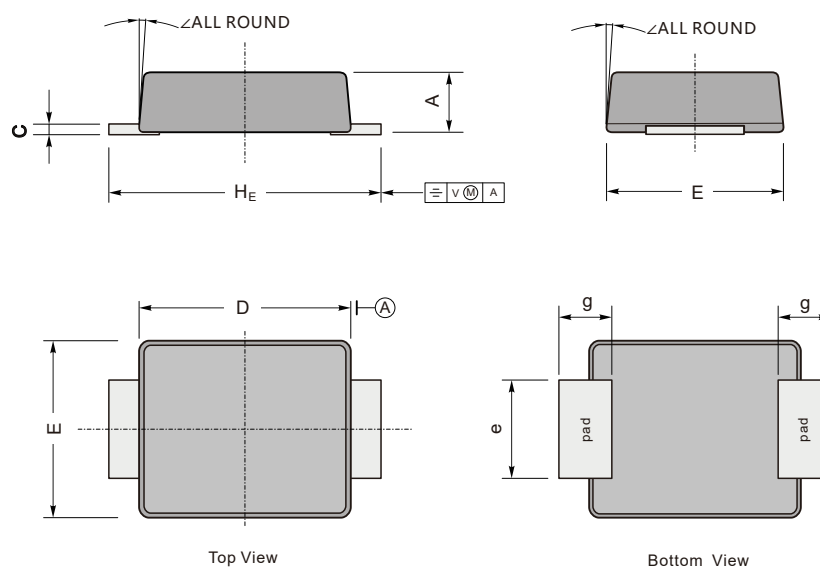


Fig. 6 Typical Transient Thermal Impedance



### Package Outline & Dimensions



UNIT		A	C	D	E	H <sub>E</sub>	e	g	∠
mm	max	1.3	0.26	4.4	3.7	5.5	2.2	1.0	9°
	min	1.1	0.18	4.2	3.5	5.1	1.9		
mil	max	51	10	173	146	216	86	40	
	min	43	7	165	138	200	75		

### Marking

Type Number	SS32BGF	SS34BGF	SS36BGF	SS38BGF	SS310BGF	SS312BGF	SS315BGF	SS320BGF
Making	S32B	S34B	S36B	S38B	S310B	S312B	S315B	S320B

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